NOV 2 0 2009

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

REFLOW	SOLDERING APPARATUS				
			<u> </u>		
	n of which is attached hereto unl				
was filed on	MAY 1, 2003 as United States	Application Number of	r PC 1 international	•	
Application	Number <u>PCT/JP03/05589</u> and v	vas amended on	(if applicable).		
I hereby state th	nat I have reviewed and understar ended by any amendment referre	nd the contents of the a d above.	bove-identified specification,	including the	
I acknowledge (Regulations, §	the duty to disclose information	which is material to pa	tentability as defined in Title	37, Code of Federal	
I hereby claim	foreign priority benefits under Ti	nd have also identified	l below any foreign application	n for patent of	
inventor's certi	ficate having a filing date before	that of the application	for which priority is claimed.	Priority Claimed	
(List prior foreign applications. See	2002-141237	Japan	16/5/2002	☑ Yes ☐ No	
note A)	(Number)	(Country)	(Day/Month/Year Filed)		
	2002-288548	Japan	1/10/2002	🛛 Yes 🗌 No	
	(Number)	(Country)	(Day/Month/Year Filed)		
	2003-109942	Japan	15/4/2003	Yes □ No	
	(Number)	(Country)	(Day/Month/Year Filed)	· .	
	2003-110130	Japan	15/4/2003	☑ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)	•	
insofar as the s in the manner p	See attached list for the benefit under Title 35, Unite ubject matter of each of the clair provided by the first paragraph onich is material to patentability areen the filing date of the prior	ed States Code, § 120 ons of this application in Title 35, United States defined in Title 37.	of any United States applications not disclosed in the prior Unites Code, § 112, I acknowled Code of Federal Regulations	ge the duty to disclose, § 1.56 which became	
аррисаном.	· ·		Sta	Status	
(List prior U.S. Applications)		(Filing Date)	Patented Pending Abandoned		
	(Application Serial No.)	(Filling Date)			
	(Application Serial No.)	(Filing Date)	☐ Patented ☐ Pending ☐ Abandoned		
	•		☐ Patented ☐ Per	nding Abandoned	
	(Application Serial No.)	(Filing Date)			
•				•	

I hereby appoint the following rney(s) and/or agent(s) to prosecute this app. ion and to transact all business in the transact and Trademark Office connected therewith:

23850

Please direct all communications to the following address:

23850

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, '1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or i	irst inventor (given name, family name)	Yatsuharu YOKOTA	
	Inventor's signature	新闻八粒	Date October 15,	2004
	Residence	Same as the Post Office Address	Citizenship Japa	nese
	Post Office Address	2-5, Shiroyamate 2-chome, Hachioji-		
•		20, 52270, 52270		
	Full name of second	inventor (given name, family name)		
•	Inventor's signature	,	Date	
	Residence		Citizenship	
	Post Office Address			
	Full name of third in	ventor (given name, family name)		
	Inventor's signature	ventor (given hame, family hame)	Date	
•	Residence		Citizenship	
•	Post Office Address		-	
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	* •			
• .	Full name of fourth in Inventor's signature	nventor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			
	Fost Office Address			
	·			
•		ventor (given name, family name)	Dit	
	Inventor's signature		Date	
	Residence		Citizenship	
	Post Office Address			